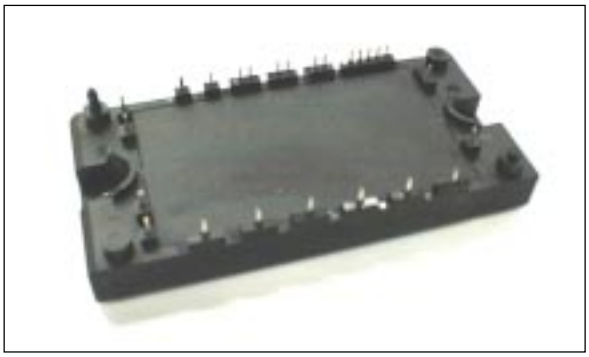
PIM/Built-in converter with thyristor and brake (S series)
1200V / 25A / PIM



■ Features

· Low V_{CE}(sat)
· Compact Package
· P.C. Board Mount Module
· Converter Diode Bridge Dynamic Brake Circuit

■ Applications

· Inverter for Motor Drive
· AC and DC Servo Drive Amplifier
· Uninterruptible Power Supply

■ Maximum ratings and characteristics

● Absolute maximum ratings (Tc=25°C unless without specified)

Item		Symbol	Condition		Rating	Unit
Inverter	Collector-Emitter voltage	V_{CES}			1200	V
	Gate-Emitter voltage	V_{GES}			±20	V
	Collector current	I_C	Continuous	Tc=25°C	35	A
				Tc=80°C	25	
		I_{CP}	1ms	Tc=25°C	70	A
				Tc=80°C	50	
		-I_C			25	A
	Collector power disspation	P_C	1 device		180	W
Brake	Collector-Emitter voltage	V_{CES}			1200	V
	Gate-Emitter voltage	V_{GES}			±20	V
	Collector current	I_C	Continuous	Tc=25°C	25	A
				Tc=80°C	15	
		I_{CP}	1ms	Tc=25°C	50	A
				Tc=80°C	30	
	Collector power disspation	P_C	1 device		110	W
	Repetitive peak reverse voltage(Diode)	V_{RRM}			1200	V
Thyristor	Repetitive peak off-state voltage	V_{DRM}			1600	V
	Repetitive peak reverse voltage	V_{RRM}			1600	V
	Average on-state current	$I_{T(AV)}$	50Hz/60Hz sine wave		25	A
	Surge 0n-state current (Non-Repetitive)	I_{TSM}	Tj=125°C, 10ms half sine wave		290	A
	Junction temperature	T_{jw}			125	℃
Converter	Repetitive peak reverse voltage	V_{RRM}			1600	V
	Average output current	I_O	50Hz/60Hz sine wave		25	A
	Surge current (Non-Repetitive)	I_{FSM}	Tj=150°C, 10ms		260	A
	I^2t (Non-Repetitive)	I^2t	half sine wave		338	A^2s
Junction temperature (except Thyristor)		T_j			+150	℃
Storage temperature		T_{stg}			-40 to +125	℃
Isolation between terminal and copper base *2		V_{iso}	AC : 1 minute		AC 2500	V
voltage between thermistor and others *3					AC 2500	V
Mounting screw torque					1.7 *1	N·m

*1 Recommendable value : 1.3 to 1.7 N·m (M4)
*2 All terminals should be connected together when isolation test will be done.
*3 Terminal 8 and 9 should be connected together. Terminal 1 to 7 and 10 to 26 should be connected together and shorted to copper base.

● Electrical characteristics (Tj=25°C unless otherwise specified)

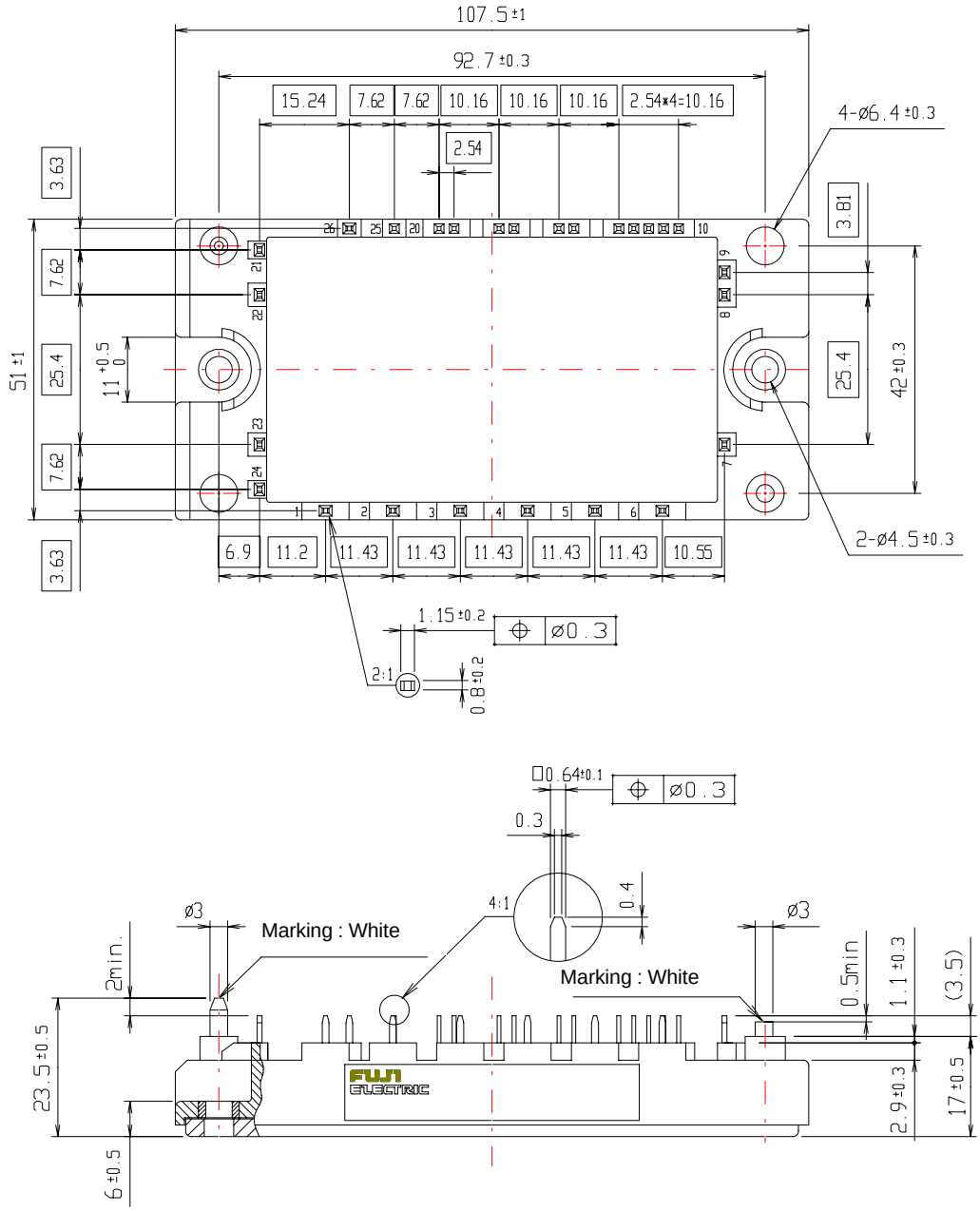
Item		Symbol	Condition		Characteristics			Unit
					Min.	Typ.	Max.	
Inverter	Zero gate voltage collector current	I_{CES}	V_{CE}=1200V, V_{GE}=0V				100	μA
	Gate-Emitter leakage current	I_{GES}	V_{CE}=0V, V_{GE}=±20V				200	nA
	Gate-Emitter threshold voltage	$V_{GE(th)}$	V_{CE}=20V, I_C=25mA		5.5	7.2	8.5	V
	Collector-Emitter saturation voltage	$V_{CE(sat)}$	V_{GE}=15V, Ic=25A	chip		2.1		V
				terminal		2.2	2.6	
	Input capacitance	C_{ies}	V_{GE}=0V, V_{CE}=10V, f=1MHz			3000		pF
	Turn-on time	t_{on}	V_{CC}=600V			0.35	1.2	μs
		t_r	I_C=25A			0.25	0.6	
	Turn-off	t_{off}	V_{GE}=±15V			0.45	1.0	
		t_f	R_G=51Ω			0.08	0.3	
	Forward on voltage	V_F	I_F=25A	chip		2.3		V
				terminal		2.4	3.2	
	Reverse recovery time of FRD	t_{rr}	I_F=25A				350	ns
Brake	Zero gate voltage collector current	I_{CES}	V_{CES}=1200V, V_{GE}=0V				100	μA
	Gate-Emitter leakage current	I_{GES}	V_{CE}=0V, V_{GE}=±20V				200	nA
	Collector-Emitter saturation voltage	$V_{CE(sat)}$	I_C=15A, V_{GE}=15V	chip		2.1		V
				terminal		2.2	2.6	
	Turn-on time	t_{on}	V_{CC}=600V			0.35	1.2	μs
		t_r	I_C=15A			0.25	0.6	
	Turn-off time	t_{off}	V_{GE}=±15V			0.45	1.0	
		t_f	R_G=82Ω			0.08	0.3	
	Reverse current	I_{RRM}	V_R=1200V				100	μA
	off-state current	I_{DM}	V_{DM}=1600V				1.0	mA
Thyristor	Reverse current	I_{RRM}	V_{RM}=1600V				1.0	mA
	Gate trigger current	I_{GT}	V_D=6V, I_T=1A				100	mA
	Gate trigger voltage	V_{GT}	V_D=6V, I_T=1A				2.5	V
	On-state voltage	V_{TM}	I_{TM}=25A	chip		1.05	1.15	V
				terminal		1.1		
Converter	Forward on voltage	V_{FM}	I_F=25A	chip		1.1		V
				terminal		1.2	1.5	
	Reverse current	I_{RRM}	V_R=1600V				100	μA
Thermistor	Resistance	R	T=25°C			5000		Ω
			T=100°C		465	495	520	
	B value	B	T=25/50°C		3305	3375	3450	K

● Thermal resistance Characteristics

Item	Symbol	Condition	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance (1 device)	Rth(j-c)	Inverter IGBT			0.69	°C/W
		Inverter FWD			1.30	
		Brake IGBT			1.14	
		Thyristor			1.00	
		Converter Diode			0.90	
Contact thermal resistance *	Rth(c-f)	With thermal compound		0.05		

* This is the value which is defined mounting on the additional cooling fin with thermal compound

■ Outline Drawings, mm



■ Equivalent Circuit Schematic